2023 IEEE Symposium on High-Performance Interconnects (HOTI 2023)

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Debendra Das Sharma (Intel Corporation, USA) and Swadesh Choudhary
(Intel Corporation, USA)

Vinayak Agrawal (Intel Corporation, India), Francois Piednoel
(Mercedez Benz, USA), Igor Elkanovich (Global Unichip, Israel),
Dwaipayan Sil (Intel Corporation, USA), and Mirza Jahan (Intel
Corporation, USA)

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Rafael Oliveira (Georgia Institute of Technology) and Ada Gavrilovska
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